| ASSOCIATION CONNECTING<br>ASSOCIATION CONNECTING<br>LECTRONICS INDUSTRIES | IPC. Bannockl | ourn, Illinois, A  | Il rights reserved untions. | under both              | This docume<br>level parts, t   | ent is a declaration entities of the declaration entities | on of the su                  | bstances v<br>all lower | within the manufactu<br>level materials for w | rer listed i                    | tem. Note:<br>nanufacture | if the item is an as<br>r has engineering | sembly with low responsibility. |
|---|---------------|--------------------|-----------------------------|-------------------------|---|---|-------------------------------|-------------------------|---|---------------------------------|---------------------------|---|---------------------------------|
|   |               |                    |                             | Form Type<br>Distribute | * Declaration Class *<br>Class 6 - RoHS Yes/No, Homogeneous Materials |   |                               |                         | ials and M                                    | ls and Mfg Information          |                           |   |                                 |
| Supplier Information  |               |                    |                             |                         |   |   |                               |                         |   |                                 |                           |   |                                 |
| Company name* Cor   |               |                    | Company unique ID           |                         |   | Unique ID Authority   |                               |                         |   | Response Date*                  |                           |   |                                 |
| nsemi   |               |                    |                             |                         |   |   |                               |                         |   | 2024-04-19                      |                           |   |                                 |
| Contact Name Title - Contact  |               |                    | t ·                         |                         |   | Phone - Contact*  |                               |                         |   | Email - Contact*                |                           |   |                                 |
| Product-Env-Stewards Product Env  |               |                    | nviro Compliance            |                         |   | NA  |                               |                         |   | Product-Env-Stewards@onsemi.com |                           |   |                                 |
| Authorized Representative* Title - Representative                         |               |                    | presentative                |                         |   | Phone - Representative*   |                               |                         |   | Email - Representative*         |                           |   |                                 |
| Product-Env-Stewards Product Envir  |               |                    | wiro Compliance             |                         |   | NA  |                               |                         |   | Product-Env-Stewards@onsemi.com |                           |   |                                 |
| Requester Item Number   | Mfr Iten      | n Number           | Mfr Item Name               |                         |   | Effective Date  | te Version Manufacturing Site |                         |   | Weight*                         | UOM                       | Unit Type                                 |                                 |
|   | SZCM12        | SZCM1213A-02SR 2 C |                             | 2 CH. LOW CAP ESD       |   | 2024-04-19  |                               | C                       | CN1   |                                 | 10.87                     | mg  | Each                            |
| Ianufacturing Proccess Informa  | ntion         |                    |                             |                         |   |   |                               | ·                       |   |                                 |                           |   |                                 |
| Terminal Plating / Grid Array M   | laterial 7    | Ferminal Base      | Alloy J-STD-020 MSL Ra      |                         | L Rating  | Peak Proce  | Process Body Temperati        |                         | ure Max Time at Peak Temper                   |                                 | ure Num                   | ber of Reflow Cyc                         | les                             |
| Matte Tin (Sn) - annealed CU Alloy  |               | CU Alloy           |                             | 1                       |   | 260   |                               | С                       | 30  | secon                           | ds 3                      |   |                                 |
| omments   |               |                    |                             |                         |   |   |                               |                         |   |                                 |                           |   |                                 |
| vel 1 - maximum time at peak temperat                                     | ure during so | ldering is 10-3    | 0 seconds                   |                         |   |   |                               |                         |   |                                 |                           |   |                                 |
| or more information regarding materia                                     | l composition | please refer to    | page 3                      |                         |   |   |                               |                         |   |                                 |                           |   |                                 |

| RoHS Material Composition Declaration  |   |  |   | Declaration Type *                              | Detailed  |  |  |  |  |  |
|--|---|--|---|---|---|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP). |  |   |   |   |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>v others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the  | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and co<br>for issues that arise regarding inform | ce of its products with European Union membe    | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa   | ances per the definitio  | on above  | Supplier Acceptance                             | * Accepted  |  |  |  |  |  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per  | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i   | n the RoHS Declaration above and choose all   |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU  |  |   |   |   |  |  |  |  |  |
| Declaration Signature  |   |  |   |   |   |  |  |  |  |  |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester   | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital | lly sign the declaration (if required by the  |  |  |  |  |  |
| Supplier Digital Signature Ra  | stislav Drska   | Le   |   |   |   |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| Homogeneous Material | Weight | Unit of Measure | Level    | Substance                    | CAS        | Exempt | Weight | Unit of Measure |
|----------------------|--------|-----------------|----------|------------------------------|------------|--------|--------|-----------------|
| Die                  | 0.09   | mg              | Supplier | Silicon (Si)                 | 7440-21-3  |        | 0.09   | mg              |
| Lead Frame           | 3.47   | mg              | Supplier | Silver (Ag)                  | 7440-22-4  |        | 0.0357 | mg              |
|                      |        |                 | Supplier | Zinc (Zn)                    | 7440-66-6  |        | 0.0326 | mg              |
|                      |        |                 | Supplier | Iron (Fe)                    | 7439-89-6  |        | 0.0812 | mg              |
|                      |        |                 | Supplier | Copper (Cu)                  | 7440-50-8  |        | 3.3173 | mg              |
|                      |        |                 | Supplier | Phosphorus (P)               | 7723-14-0  |        | 0.0031 | mg              |
| Mold Compound-Black  | 6.91   | mg              | Supplier | Ortho Cresol Novolac Resin   | 29690-82-2 |        | 0.691  | mg              |
|                      |        |                 | Supplier | Carbon Black (C)             | 1333-86-4  |        | 0.0345 | mg              |
|                      |        |                 | Supplier | Aluminum Hydroxide (Al(OH)3) | 21645-51-2 |        | 1.0019 | mg              |
|                      |        |                 | Supplier | Fused Silica (SiO2)          | 60676-86-0 |        | 4.4915 | mg              |
|                      |        |                 | Supplier | Phenolic Resin (Novolac)     | 9003-35-4  |        | 0.691  | mg              |
| Plating              | 0.38   | mg              | Supplier | Tin (Sn)                     | 7440-31-5  |        | 0.38   | mg              |
| Wire Bond - Au       | 0.02   | mg              | Supplier | Gold (Au)                    | 7440-57-5  |        | 0.02   | mg              |